## **FS2230BF**

## N-Channel Enhancement Mode Field Effect Transistor

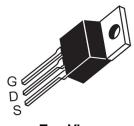
#### Features

- · N-channel, normal leve
- Excellent gate charge x R<sub>DS(on)</sub> product (FOM)
- Very low on-resistance R<sub>DS(on)</sub>
- 175 °C operating temperature
- Pb-free lead plating; RoHS compliant
- Qualified according to JEDEC for target application
- · Ideal for high-frequency switching and synchronous rectification

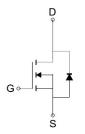
#### Product Summary

V <sub>DS</sub>	$V_{GS}$	Test Conditions	R <sub>DS(on)</sub>
60V	±20V	5.5A@VGS=10V	30mR
		4.5A@ VGS=4V5	35mR

#### Pin Configurations(TO220)







N-Channel MOSFET

#### Absolute Maximum Ratings TA=25°C unless otherwise noted

Parameter		Symbol	Ratings	Unit
Drain-Source Voltage		V <sub>DSS</sub>	60	V
Gate-Source Voltage		V <sub>GSS</sub>	±20	V
Drain Current	Continuous	I <sub>D</sub>	6 <sup>(1A)</sup> 26 <sup>(1B)</sup>	А
	Pulse	I <sub>DM</sub>	80	
Total Power Dissipation (note1)		P <sub>D</sub>	2.5 <sup>(1A)</sup>	w
		, D	50 <sup>(1B)</sup>	
Operating and Storage Junction Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

#### Notes

- 1A. Surface Mounted on 1x1FR4 Board.
- 1B. Pulse width limited maximum junction temperature Pulse test: PW  $\leq$  300 us duty cycle  $\leq$  2%
- 2. The value of PD is measured with the device mounted on 1in 2 FR-4 board with 2oz. Copper, in a still air environment with TA =25° C. The value in any given application depends on the user's specific board design. The current rating is based on the DC thermal resistance rating and PCB layout: A. Minimum footprint; B. With additional heat sink.
- 3. Repetitive rating, pulse width limited by junction temperature

### Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

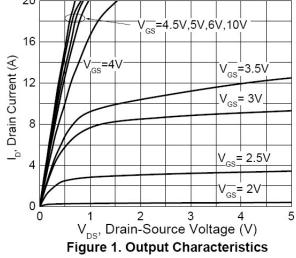
Parameter (note2)	Symbol	Test Conditions	Min	Тур	Max	Unit
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 uA	60			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V			1	uA
Gate–Body Leakage	l GSS	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \text{ uA}$	1	1.4	3	V
Static Drain–Source On–Resistance	R <sub>DS(ON)</sub>	$V_{GS} = 10 \text{ V}, I_{D} = 5.5 \text{ A}$		30	41	mR
		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 4.5 A		35	52	
Input Capacitance	C <sub>ISS</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V,		1180		pF
		F = 1MHz				
Output Capacitance	C <sub>oss</sub>			170		
Reverse Transfer Capacitance	C <sub>RSS</sub>			100		
Turn-On Delay Time	T <sub>D(ON)</sub>	V <sub>GS</sub> =10V, V <sub>DS</sub> =30V,			25	nS
		R <sub>L</sub> =5.4R,				
		$R_{GEN}$ =3R, $I_{D}$ =5.5A				
Turn–On Rise Time	T <sub>R</sub>				70	
Turn–Off Delay Tim	$T_{D(OFF)}$				300	
Turn–Off Fall Time	T <sub>F</sub>				150	
Diode Forward Voltage	V <sub>SD</sub>	$V_{GS} = 0 \text{ V}, I_{S} = 2 \text{ A}$	0.5	0.77	1.0	٧

<sup>1.</sup> The value of PD is measured with the device mounted on 1in 2 FR-4 board with 2oz. Copper, in a still air environment with TA =25° C. The value in any given application depends on the user's specific board design. The current rating is based on the DC thermal resistance rating and PCB layout: A. Minimum footprint; B. With additional heat sink.

<sup>2.</sup> Repetitive rating, pulse width limited by junction temperature

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### TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)



60

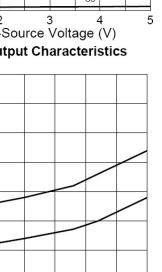
50

40

30

0

On Resistance (mR)



20

I<sub>D</sub>, Drain Current (A) Figure 3. On-Resistance

10

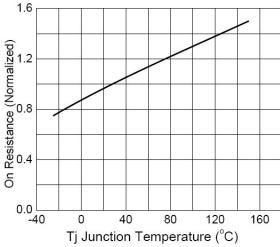
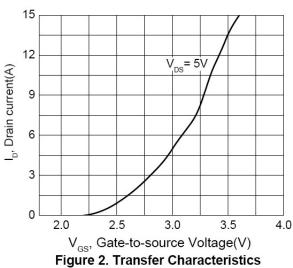


Figure 5. On-Resistance vs. Temperature



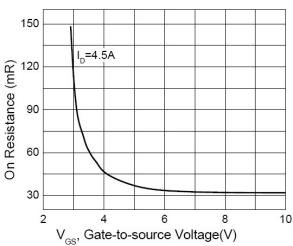


Figure 4. On-Resistance vs. Threshold Voltage

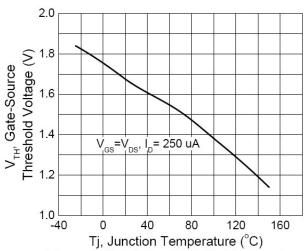
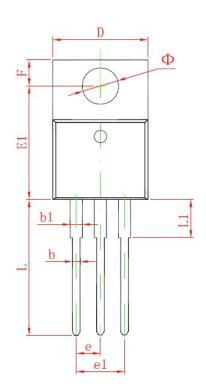


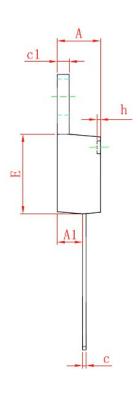
Figure 6. Gate Threshold Vs. Temperature

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## Package Information

TO220





Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
Α	4.470	4.670	0.176	0.184	
A1	2.520	2.820	0.099	0.111	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.310	0.530	0.012	0.021	
c1	1.170	1.370	0.046	0.054	
D	10.010	10.310	0.394	0.406	
E	8.500	8.900	0.335	0.350	
E1	12.060	12.460	0.475	0.491	
е	2.540 TYP		0.100 TYP		
e1	4.980	5.180	0.196	0.204	
F	2.590	2.890	0.102	0.114	
h	0.000	0.300	0.000	0.012	
L_	13.400	13.800	0.528	0.543	
L1	3.560	3.960	0.140	0.156	
Ф	3.735	3.935	0.147	0.155	